

## U417-VB Datasheet

### P-Channel 30-V (D-S) MOSFET

#### PRODUCT SUMMARY

$V_{DS}$ (V)	$R_{DS(on)}$ ( $\Omega$ )	$I_D$ (A) <sup>d</sup>	$Q_g$ (Typ.)
- 30	0.018 at $V_{GS} = - 10$ V	- 40	13 nC
	0.022 at $V_{GS} = - 4.5$ V	- 35	

#### FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Trench Power MOSFET
- 100 %  $R_g$  Tested

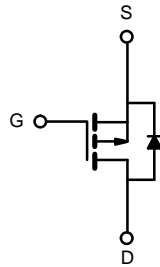
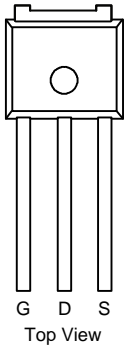


**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**  
Available

#### APPLICATIONS

- Load Switch
- Battery Switch

TO-251



P-Channel MOSFET

#### ABSOLUTE MAXIMUM RATINGS $T_A = 25^\circ\text{C}$ , unless otherwise noted

Parameter		Symbol	Limit	Unit
Drain-Source Voltage		$V_{DS}$	- 30	V
Gate-Source Voltage		$V_{GS}$	$\pm 20$	
Continuous Drain Current ( $T_J = 150^\circ\text{C}$ )	$T_C = 25^\circ\text{C}$	$I_D$	- 40	A
	$T_C = 70^\circ\text{C}$		- 35	
	$T_A = 25^\circ\text{C}$		- 30.0 <sup>a, b</sup>	
	$T_A = 70^\circ\text{C}$		- 28 <sup>a, b</sup>	
Pulsed Drain Current		$I_{DM}$	- 150	
Continuous Source-Drain Diode Current	$T_C = 25^\circ\text{C}$	$I_S$	- 3.5	A
	$T_A = 25^\circ\text{C}$		- 2.1 <sup>a, b</sup>	
Maximum Power Dissipation	$T_C = 25^\circ\text{C}$	$P_D$	40	W
	$T_C = 70^\circ\text{C}$		32	
	$T_A = 25^\circ\text{C}$		2.5 <sup>a, b</sup>	
	$T_A = 70^\circ\text{C}$		1.6 <sup>a, b</sup>	
Operating Junction and Storage Temperature Range		$T_J, T_{stg}$	- 55 to 150	$^\circ\text{C}$

#### THERMAL RESISTANCE RATINGS

Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>a, c</sup>	$t \leq 10$ s	$R_{thJA}$	40	50	$^\circ\text{C/W}$
Maximum Junction-to-Foot	Steady State	$R_{thJF}$	24	30	

Notes:

- Surface mounted on 1" x 1" FR4 board.
- $t = 10$  s.
- Maximum under Steady State conditions is  $95^\circ\text{C/W}$ .
- Based on  $T_C = 25^\circ\text{C}$ .

SPECIFICATIONS $T_J = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0\text{ V}$ , $I_D = -250\text{ }\mu\text{A}$	- 30			V	
$V_{DS}$ Temperature Coefficient	$\Delta V_{DS}/T_J$	$I_D = -250\text{ }\mu\text{A}$		- 31		mV/ $^{\circ}\text{C}$	
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			4.5			
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = -250\text{ }\mu\text{A}$	- 1.0		- 2.5	V	
Gate-Source Leakage	$I_{GSS}$	$V_{DS} = 0\text{ V}$ , $V_{GS} = \pm 20\text{ V}$			$\pm 100$	nA	
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -30\text{ V}$ , $V_{GS} = 0\text{ V}$			- 1	$\mu\text{A}$	
		$V_{DS} = -30\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_J = 55\text{ }^{\circ}\text{C}$			- 5		
On-State Drain Current <sup>a</sup>	$I_{D(on)}$	$V_{DS} \leq -5\text{ V}$ , $V_{GS} = -10\text{ V}$	- 20			A	
Drain-Source On-State Resistance <sup>a</sup>	$R_{DS(on)}$	$V_{GS} = -10\text{ V}$ , $I_D = -7.0\text{ A}$		0.018		$\Omega$	
		$V_{GS} = -4.5\text{ V}$ , $I_D = -5.6\text{ A}$		0.022			
Forward Transconductance <sup>a</sup>	$g_{fs}$	$V_{DS} = -15\text{ V}$ , $I_D = -7.0\text{ A}$		18		S	
Dynamic <sup>b</sup>							
Input Capacitance	$C_{iss}$	$V_{DS} = -15\text{ V}$ , $V_{GS} = 0\text{ V}$ , $f = 1\text{ MHz}$		1455		pF	
Output Capacitance	$C_{oss}$			180			
Reverse Transfer Capacitance	$C_{rss}$			145			
Total Gate Charge	$Q_g$	$V_{DS} = -15\text{ V}$ , $V_{GS} = -10\text{ V}$ , $I_D = -7.0\text{ A}$		25	38	nC	
		$V_{DS} = -15\text{ V}$ , $V_{GS} = -4.5\text{ V}$ , $I_D = -7.0\text{ A}$		13	20		
			$Q_{gs}$		3.5		
			$Q_{gd}$		5.5		
Gate Resistance	$R_g$	$f = 1\text{ MHz}$	0.4	2.0	4.0	$\Omega$	
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -15\text{ V}$ , $R_L = 2.7\text{ }\Omega$ $I_D \cong -5.6\text{ A}$ , $V_{GEN} = -10\text{ V}$ , $R_g = 1\text{ }\Omega$		10	20	ns	
Rise Time	$t_r$			13	20		
Turn-Off DelayTime	$t_{d(off)}$			23	35		
Fall Time	$t_f$			9	18		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -15\text{ V}$ , $R_L = 2.7\text{ }\Omega$ $I_D \cong -5.6\text{ A}$ , $V_{GEN} = -4.5\text{ V}$ , $R_g = 1\text{ }\Omega$		38	57		
Rise Time	$t_r$			89	134		
Turn-Off DelayTime	$t_{d(off)}$			22	33		
Fall Time	$t_f$			11	17		
Drain-Source Body Diode Characteristics							
Continous Source-Drain Diode Current	$I_S$	$T_C = 25\text{ }^{\circ}\text{C}$			- 6.5	A	
Pulse Diode Forward Current	$I_{SM}$				- 30		
Body Diode Voltage	$V_{SD}$	$I_S = -5.6\text{ A}$ , $V_{GS} = 0\text{ V}$		- 0.71	- 1.2	V	
Body Diode Reverse Recovery Time	$t_{rr}$	$I_F = -5.6\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$ , $T_J = 25\text{ }^{\circ}\text{C}$		22	33	ns	
Body Diode Reverse Recovery Charge	$Q_{rr}$			17	26	nC	
Reverse Recovery Fall Time	$t_a$			13		ns	
Reverse Recovery Rise Time	$t_b$			9			

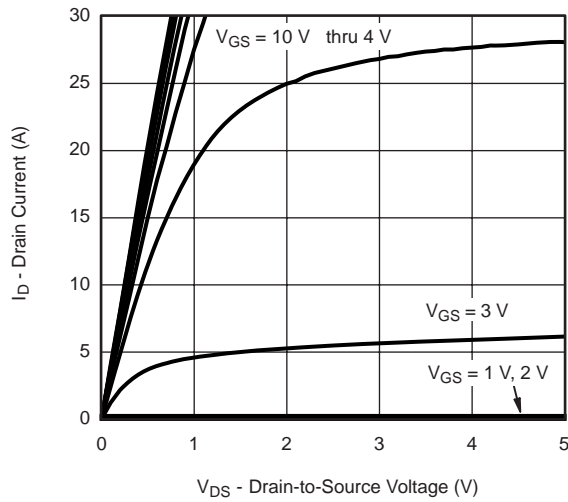
Notes:

a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .

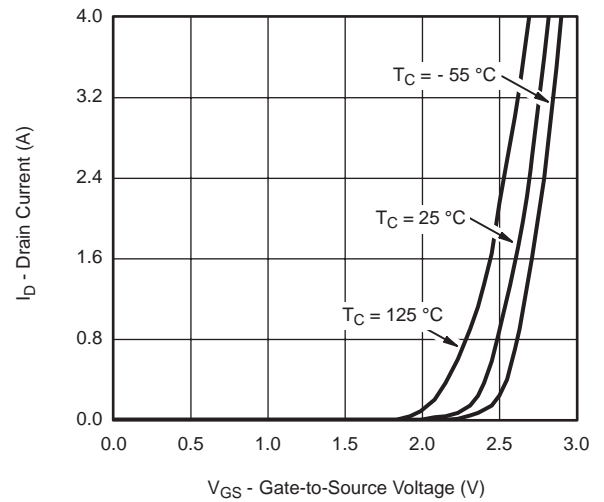
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

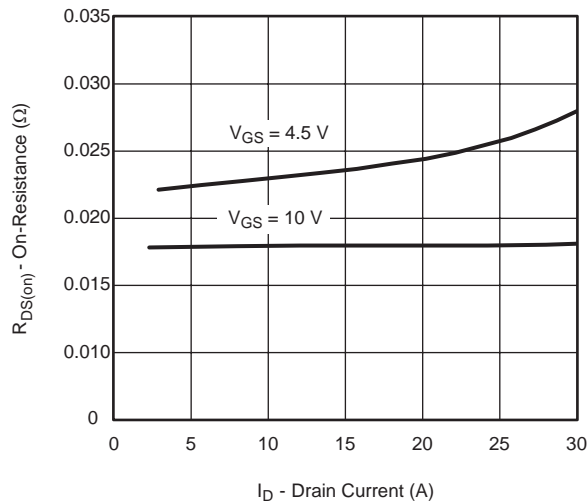
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



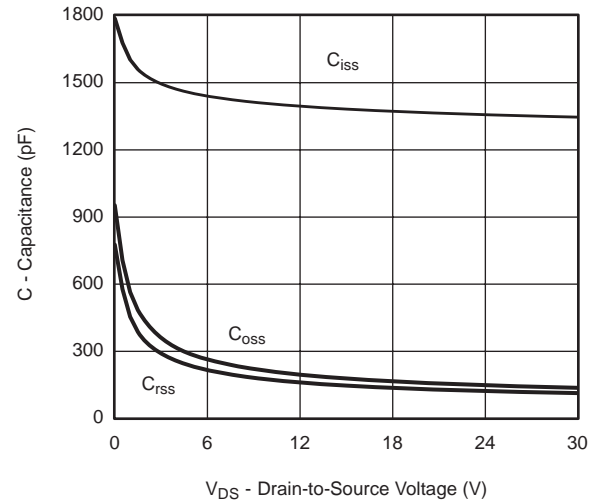
**Output Characteristics**



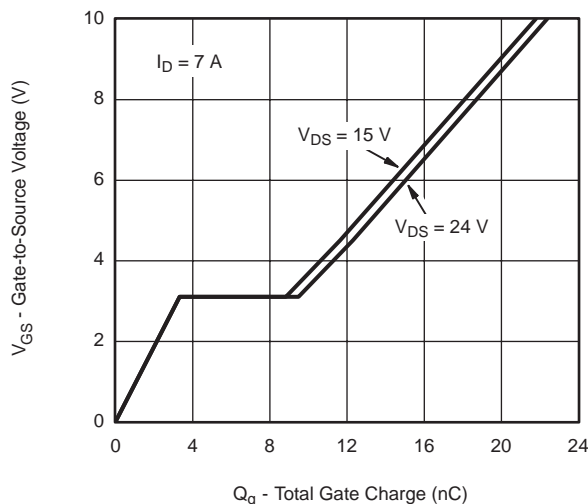
**Transfer Characteristics**



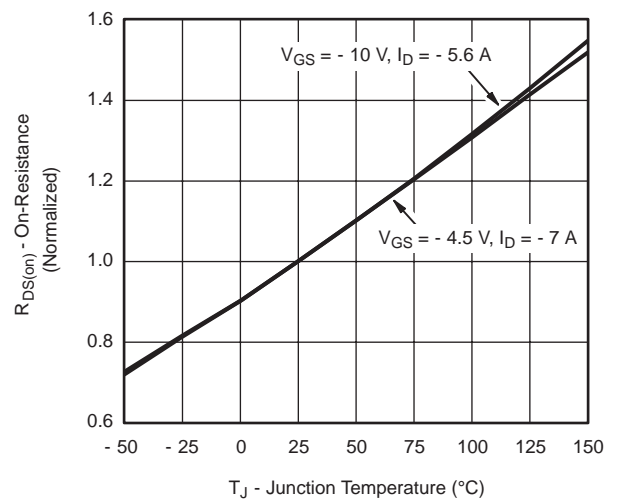
**On-Resistance vs. Drain Current**



**Capacitance**

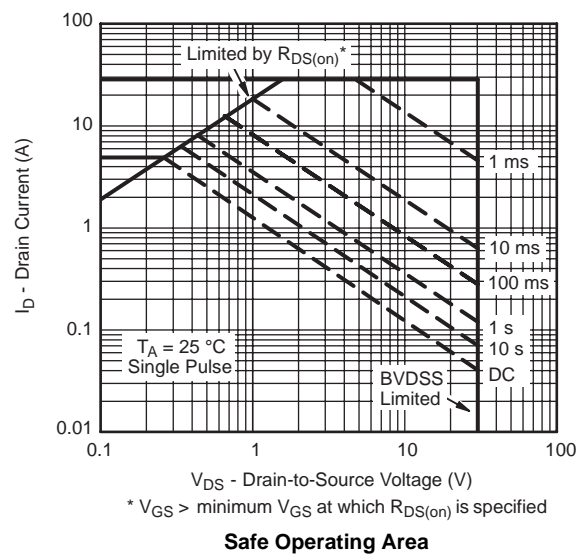
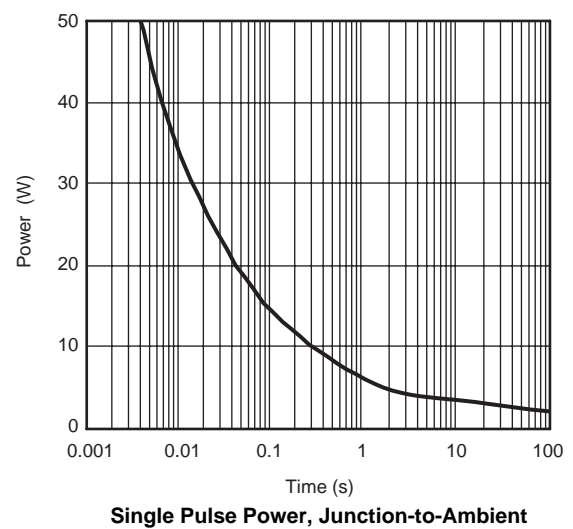
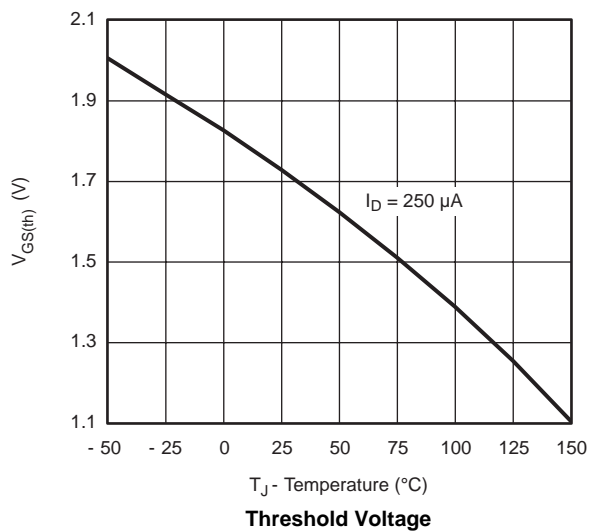
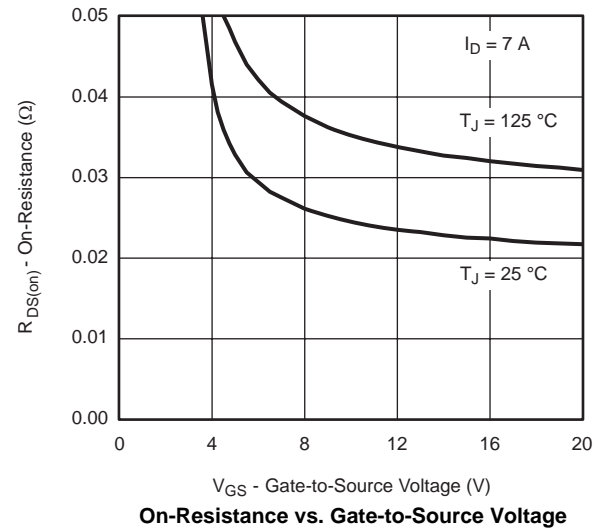
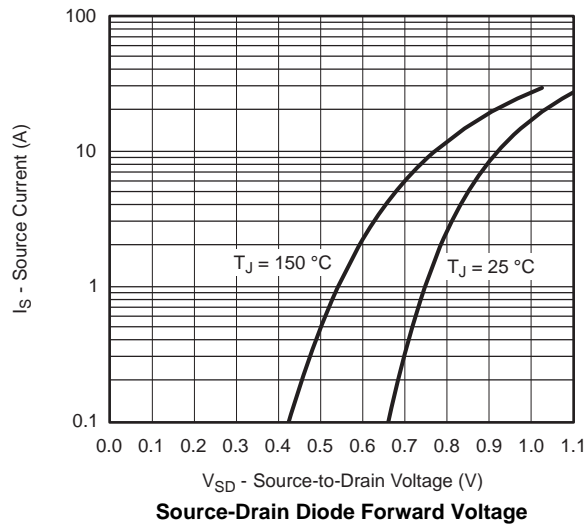


**Gate Charge**

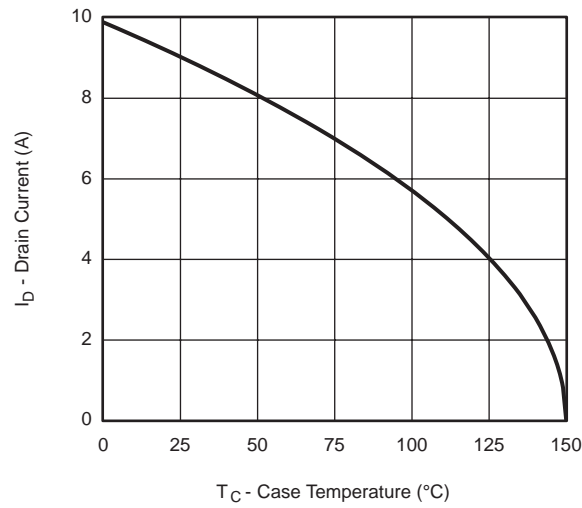


**On-Resistance vs. Junction Temperature**

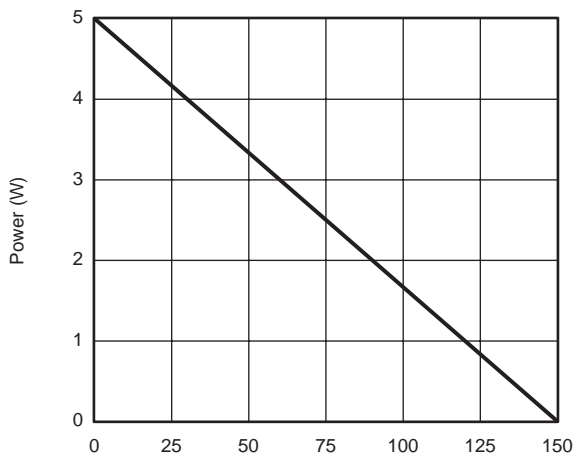
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



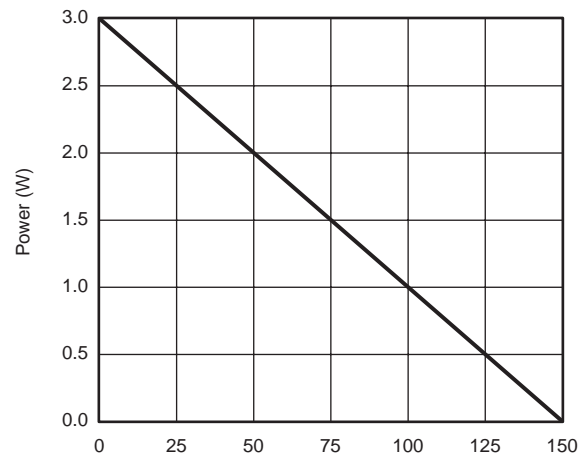
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



**Current Derating\***

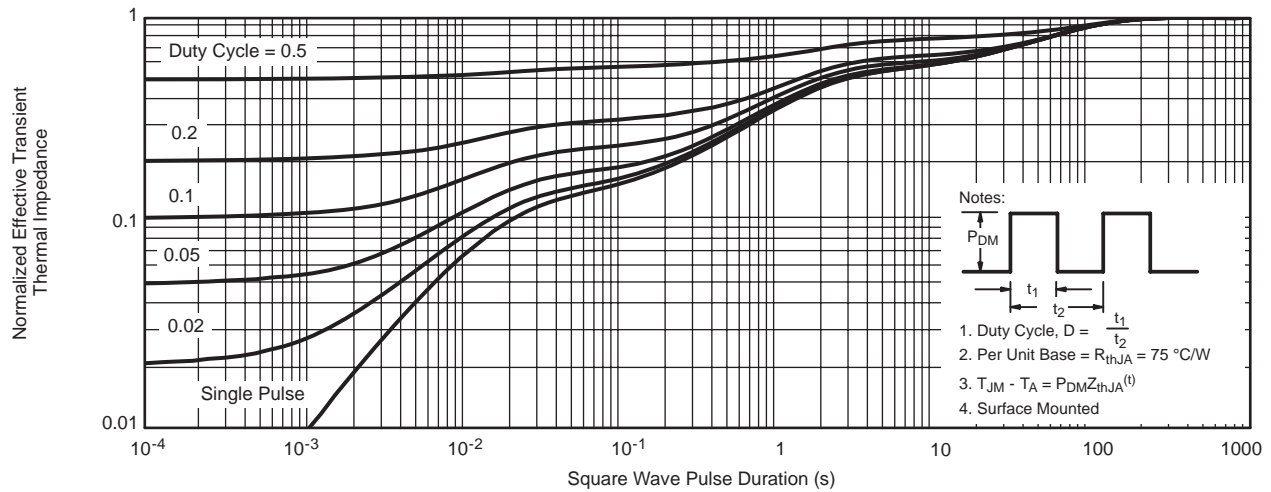
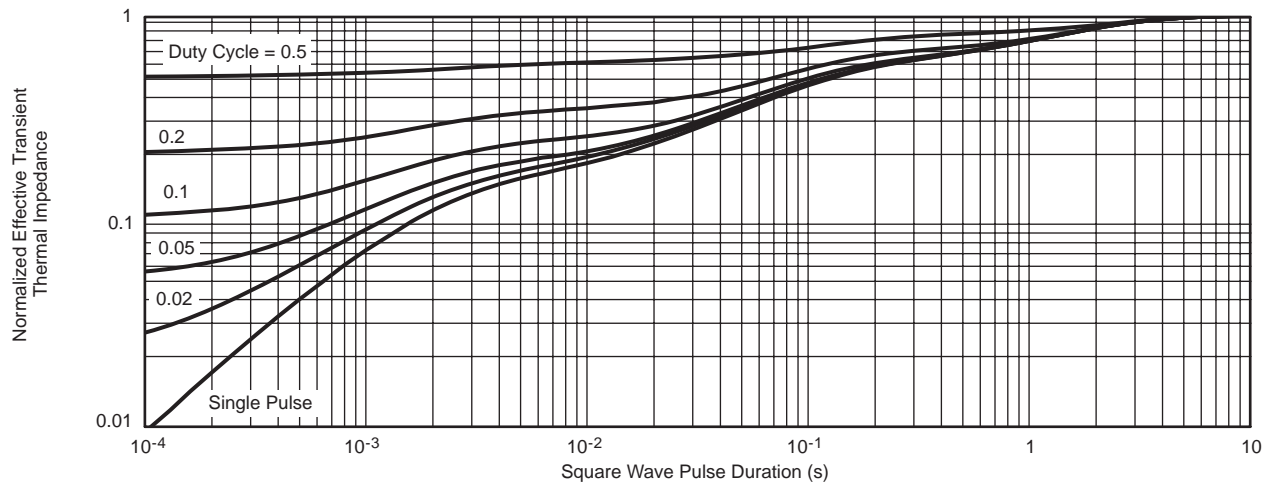


**Power, Junction-to-Foot**

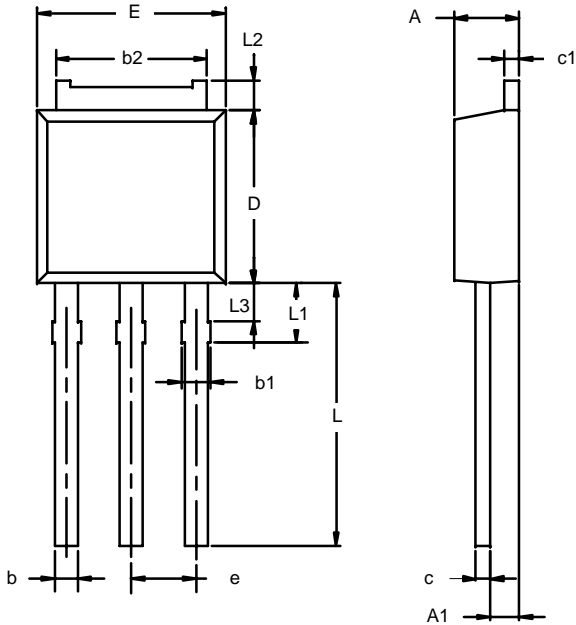


**Power Derating, Junction-to-Ambient**

\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

**Normalized Thermal Transient Impedance, Junction-to-Ambient**

**Normalized Thermal Transient Impedance, Junction-to-Foot**

**TO-251AA (DPAK)**



Note: Dimension L3 is for reference only.

Dim	MILLIMETERS		INCHES	
	Min	Max	Min	Max
A	2.21	2.38	0.087	0.094
A1	0.89	1.14	0.035	0.045
b	0.71	0.89	0.028	0.035
b1	0.76	1.14	0.030	0.045
b2	5.23	5.43	0.206	0.214
c	0.46	0.58	0.018	0.023
c1	0.46	0.58	0.018	0.023
D	5.97	6.22	0.235	0.245
E	6.48	6.73	0.255	0.265
e	2.28 BSC		0.090 BSC	
L	3.89	9.53	0.153	0.375
L1	1.91	2.28	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.15	1.52	0.045	0.060
ECN: S-03946—Rev. E, 09-Jul-01 DWG: 5346				

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